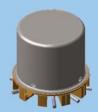


SMT DPDT Non-Latching Electromechanical Relay Signal Integrity up to 20Gbps



HIGH REPEATABILITY, DC-8 GHz/20Gbps TO-5 RELAYS, DPDT



SERIES	RELAY TYPE	
SGRF312	Repeatable, Surface-Mount J-Lead RF relay	
SGRF332	Low Power Operating Coil, Surface-Mount J-Lead RF relay	

DESCRIPTION

The ultra miniature SGRF312 is designed to improve upon the SGRF300/SGRF303 relay's high frequency performance. The SGRF312/SGRF332 offers monotonic insertion loss to 8 GHz. This improvement in RF insertion loss over the frequency range, makes these relays highly suitable for use in attenuator and other RF circuits. The sensitive SGRF332 relay has a high resistance coil, thus requiring extremely low operating power (200 mW typical).

- · High repeatability.
- · Broader bandwidth.
- · Metal enclosure for EMI shielding.
- · Ground pin option to improve case grounding.
- · High isolation between control and signal paths.
- · Highly resistant to ESD.

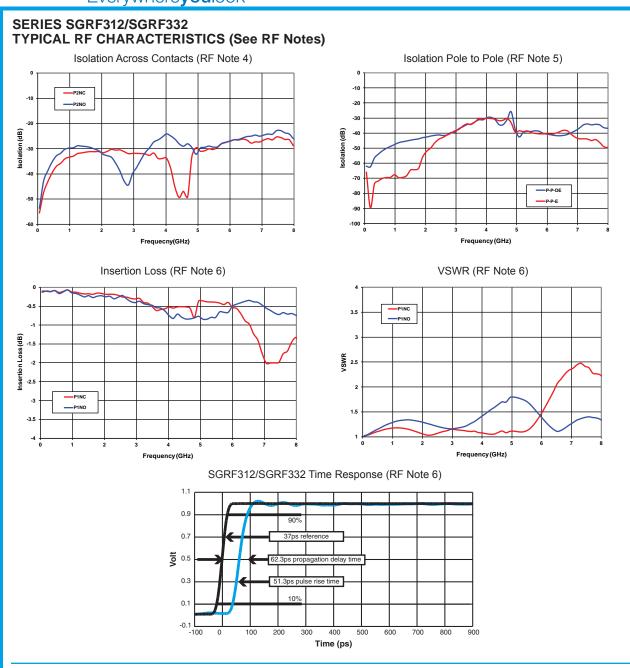
CONSTRUCTION FEATURES

The following unique construction features and manufacturing techniques provide excellent resistance to environmental extremes and overall high reliability.

- Uni-frame motor design provides high magnetic efficiency and mechanical rigidity.
- Minimum mass components and welded construction provide maximum resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Gold-plated precious metal alloy contacts ensure reliable switching.
- · Hermetically sealed.

ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS					
Temperature	Storage	–65°C to +125°C			
(Ambient)	Operating	–55°C to +85°C			
Vibration (General Note I)		10 g's to 500 Hz			
Shock (General Note I)		30 g's, 6ms half sine			
Enclosure		Hermetically sealed			
Weight		0.09 oz. (2.55g) max.			

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RF NOTES

- Test conditions: a. Fixture: .031" copper clad, reinforced PTFE, RT/duroid® 6002 with SMA connectors. (RT/duroid® is a registered trademark of Rogers Corporation.)
 - b. Room ambient temperature.
 - c. Terminals not tested were terminated with 50-ohm load.
 - d. Contact signal level: -10 dBm.
 - e. No. of test samples: 4.
- 2. Data presented herein represents typical characteristics and is not intended for use as specification limits.
- 3. Data is per pole, except for pole-to-pole data.
- 4. Data is the average from readings taken on all open contacts.
- 5. Data is the average from readings taken on poles with coil energized and de-energized.
- 6. Data is the average from readings taken on all closed contacts.
- 7. Test fixture effect de-embedded from frequency and time response data.



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SERIES SGRF312/SGRF332 GENERAL ELECTRICAL SPECIFICATIONS (@25°C)

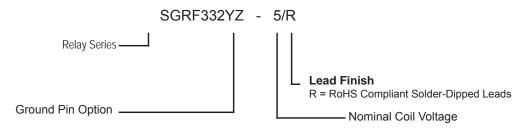
Contact Arrangement	2 Form C (DPDT)	
Rated Duty	Continuous	
Contact Resistance	0.15 Ω max.	
Contact Load Rating	Resistive: 1Amp/28Vdc Low level: 10 to 50 μA @ 10 to 50 mV	
Contact Life Ratings	1,000,000 cycles (typical) at low level contact load	
Coil Operating Power	SGRF312: 450 mW typical at nominal rated voltage SGRF332: 200 mW typical at nominal rated voltage	
Operate Time	SGRF312: 4.0 mS max. SGRF332: 6.0 mS max.	
Release Time	3.0 mS max.	
Intercontact Capacitance	0.4 pf typical	
Insulation Resistance	1,000 MΩ min. between mutually isolated terminals	
Dielectric Strength	350 Vrms (60 Hz) @ atmospheric pressure	

DETAILED ELECTRICAL SPECIFICATIONS (@25°C)

BASE PART NUMBERS (SGRF312)	SGRF312-5	SGRF312-12
Coil Voltage, Nominal (Vdc)	5.0	12.0
Coil Resistance (Ohms ±20%)	50	390
Pick-up Voltage (Vdc max.)	3.6	9.0

BASE PART NUMBERS (SGRF332)	SGRF332-5	SGRF332-12
Coil Voltage, Nominal (Vdc)	5.0	12.0
Coil Resistance (Ohms ±20%)	100	850
Pick-up Voltage (Vdc max.)	3.6	9.0

Teledyne Part Numbering System for SGRF312/SGRF332

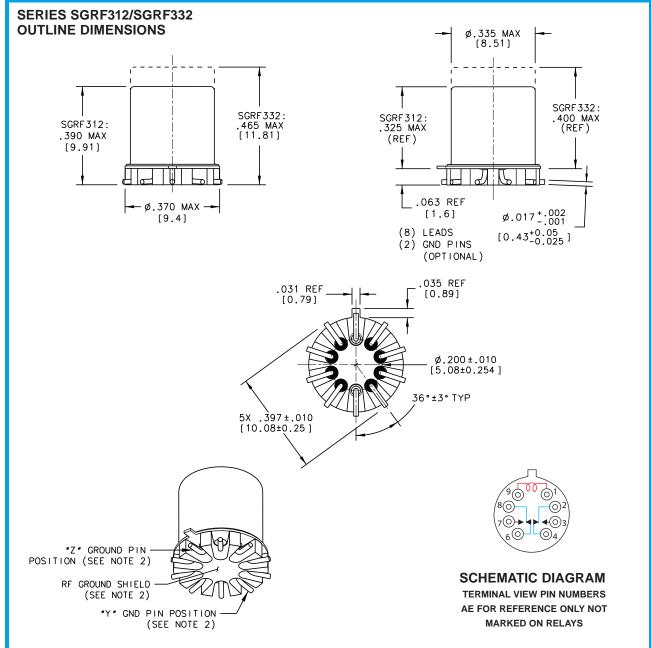


GENERAL NOTE:

PARTS ORDERED WITHOUT SUFFIX WILL BE SUPPLIED WITH (Sn60Pb40) SOLDER-COATED LEADS. PARTS ORDERED WITH ROHS SOLDER-COATED LEADS WILL HAVE (Sn99.3/Cu0.7)



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NOTES

- 1. DIMENSIONS ARE IN INCHES, METRIC EQUIVALENTS SHOWN IN [].
- 2. POSTITIONS 5 AND 10 ARE FOR UNINSULATED CASE GROUND OPTIONS.
- 3. NO PROTRUSION BELOW BOTTOM OF HEADER WHEN GROUND PINS ARE INSTALLED
- 4. TO ORDER THE CASE GROUND OPTION, AFTER THE SERIES DESIGNATOR, ADD "Y" TO THE PART NUMBER FOR POSITION 5 OR "Z" TO THE PART NUMBER FOR POSITION 10.

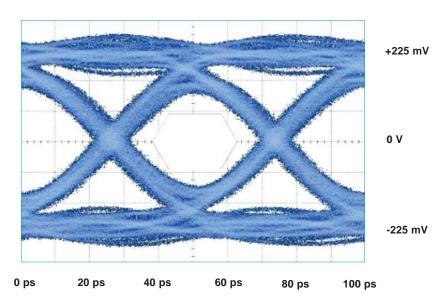
GENERAL NOTES

- I. Relays will exhibit no contact chatter in excess of 10 µsec or transfer in excess of 1 µsec.
- II. For reference only. Coil resistance not directly measureable at relay terminals due to internal series diode.



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SERIES SGRF312/SGRF332 TYPICAL Single-Ended Signal Integrity Characteristics @ 20 Gbps



Bit Rate	Eye Height	Eye Width	Jitter _{P-P}
20 Gbps	144 mV	33.3 ps	12.67 ps